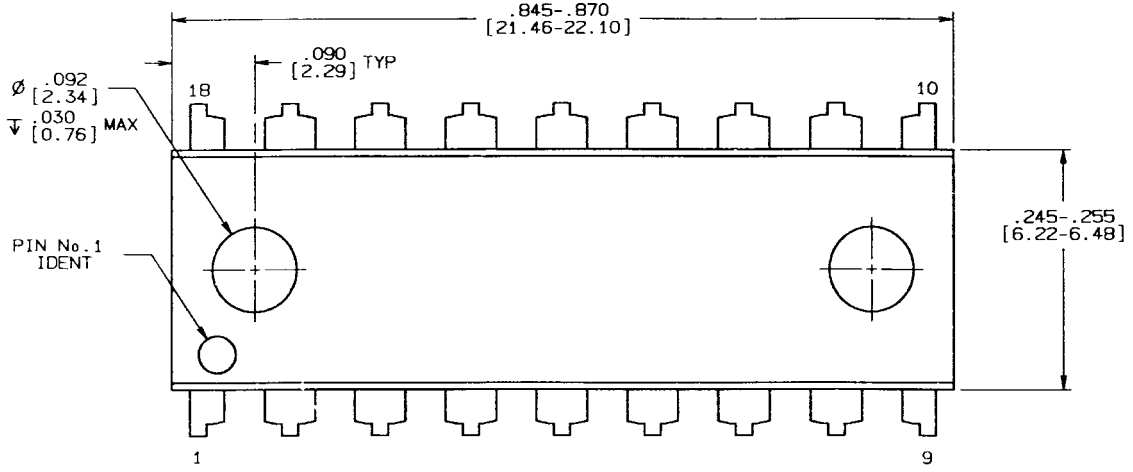
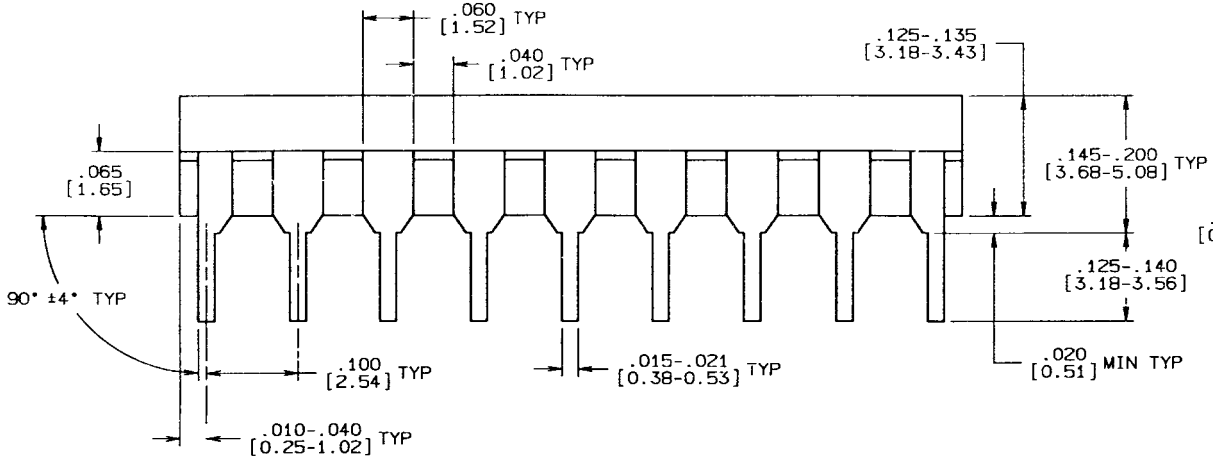
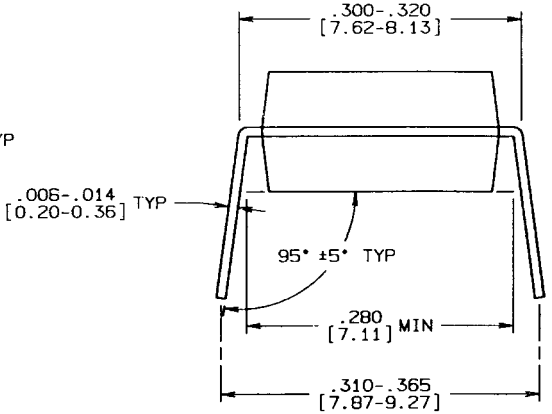
REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
F	REDRAW PER E.C.N.	09566	03/10/93	DEG/







NOTES: UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH:
   200 MICROINCHES / 5.08 MICROMETERS MINIMUM
   LEAD/TIN 37/63 OR 15/85 ON ALLOY 42 OR EQUIVALENT OR COPPER.
2. JEDEC REGISTRATION MO-095, OPTION AD, PUBILCATION
   95 (9/89).

CONTROLLING DIMENSION: INCH

APPROVALS	DATE
DRAWN D.E.GRADY	03/10/93
DFTG. CHK.	3/15/93
ENGR. CHK.	3/15/93
APPROVAL	

PROJECTION INCH [MM]

NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

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SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-N18A	F

DO NOT SCALE DRAWING | SHEET 1 OF 1